onsemi

<u>Silicon Carbide (SiC)</u> <u>MOSFET</u> – 20 mohm, 900 V, M2, TO-247-4L

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
900 V	28 mΩ @ 15 V	118 A

NVH4L020N090SC1

Features

- Typ. $R_{DS(on)} = 20 \text{ m}\Omega @ V_{GS} = 15 \text{ V}$ Typ. $R_{DS(on)} = 16 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge (typ. $Q_{G(tot)} = 196 \text{ nC}$)
- Low Effective Output Capacitance (typ. Coss = 296 pF)
- 100% UIL Tested
- AEC–Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb–Free 2LI (on second level interconnection)

Typical Applications

- Automotive Traction Inverters
- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

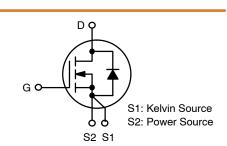
Para	Symbol	Value	Unit		
Drain-to-Source Volta	ge		V _{DSS}	900	V
Gate-to-Source Voltag	ge		V _{GS}	+22/-8	V
Recommended Operate Values of Gate-Source		T _C < 175°C	V _{GSop}	+15/–5	V
$\begin{array}{c} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$	Steady State	$T_{C} = 25^{\circ}C$	I _{DC}	116	A
Power Dissipation $R_{\theta JC}$			P _{DC}	484	W
Continuous Drain Current $R_{\theta JC}$	Steady State	$T_{\rm C}$ = 100°C	I _{DC}	82	A
Power Dissipation $R_{\theta JC}$			P _{DC}	242	W
Pulsed Drain Current (Note 2)	T _A = 25°C	I _{DM}	504	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	106	А
Single Pulse Drain-to- Energy (I _L = 23 A _{pk} , L			E _{AS}	264	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature.

3. E_{AS} of 264 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 23 A, V_{DD} = 100 V, V_{GS} = 15 V.



N-CHANNEL MOSFET



MARKING DIAGRAM

H4L020 090SC1 &Z&3&K \$Y H4L020090SC1 = Specific Device Code &Z = Assembly Plant Code &3 = Date Code (Year & Week) &K = Lot \$Y = onsemi Logo

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Мах	Unit
Thermal Resistance Junction-to-Case (Note 1)	$R_{ extsf{ heta}JC}$	0.31	°C/W
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 1 mA$		900			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 1 mA, refer	to 25°C		500		mV/∘C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			100	μΑ
		V _{DS} = 900 V	T _J = 175°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +22/-8$ V	, V _{DS} = 0 V			±1	μΑ
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, I_D	= 20 mA	1.8	2.7	4.3	V
Recommended Gate Voltage	V _{GOP}			-5		+15	V
Drain-to-Source On Resistance	R _{DS(on)}	$\begin{array}{ c c c c c } \hline R_{DS(on)} & V_{GS} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C} \\ \hline V_{GS} = 18 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C} \\ \hline V_{GS} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C} \end{array}$			20	28	mΩ
					16		
					27		
Forward Transconductance	9 _{FS}	V _{DS} = 20 V, I _D = 60 A			49		S
CHARGES, CAPACITANCES & GATE RI	ESISTANCE			-			
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz,			4415		pF
Output Capacitance	C _{OSS}	V _{DS} = 450 V			296		1
Reverse Transfer Capacitance	C _{RSS}				24		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5/15 V$,	V _{DS} = 720 V,		196		nC
Threshold Gate Charge	Q _{G(TH)}	I _D = 60 A			42		
Gate-to-Source Charge	Q _{GS}				78		
Gate-to-Drain Charge	Q _{GD}				55		1
Gate-Resistance	R _G	f = 1 MHz			1.6		Ω
SWITCHING CHARACTERISTICS	•			•	-	•	
Turn–On Delay Time	t _{d(ON)}	$V_{GS} = -5/15 V_{,}$	V _{DS} = 720 V,		29		ns
Rise Time	t _r	I _D = 60 A, R _G = Inductive Load	2.5 Ω,		28		
Turn-Off Delay Time	t _{d(OFF)}				54	1	

Rise Time	t _r	Inductive Load		28			
Turn-Off Delay Time	t _{d(OFF)}			54			
Fall Time	t _f			14			
Turn-On Switching Loss	E _{ON}			611		μJ	
Turn-Off Switching Loss	E _{OFF}			293			
Total Switching Loss	E _{TOT}			904			
DRAIN-SOURCE DIODE CHARACTERISTICS							

DRAIN-SOURCE DIODE CHARACTERISTICS

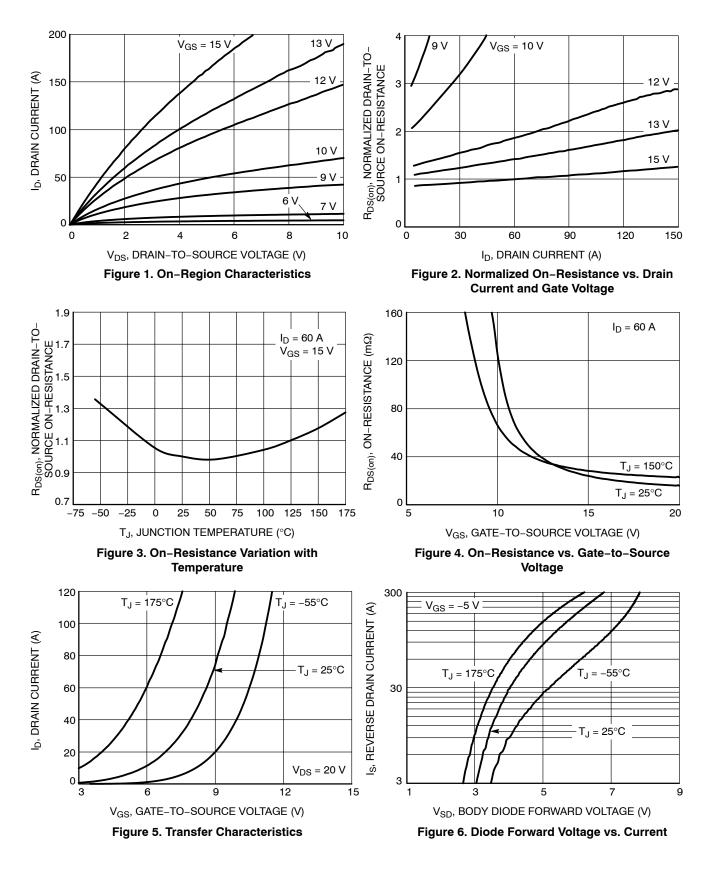
Continuous Drain-Source Diode Forward Current	I _{SD}	V_{GS} = -5 V, T_{J} = 25°C		106	A
Pulsed Drain-Source Diode Forward Current (Note 2)	I _{SDM}	V_{GS} = -5 V, T_{J} = 25°C		504	A
Forward Diode Voltage	V _{SD}	V_{GS} = –5 V, I_{SD} = 30 A, T_J = 25°C	3.8		V

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated) (continued)

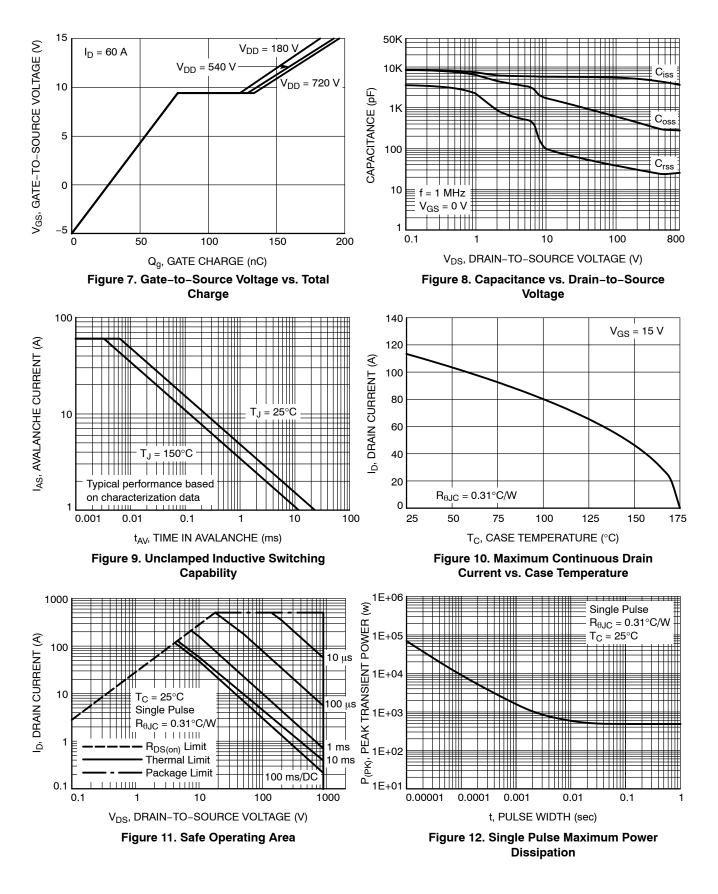
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
DRAIN-SOURCE DIODE CHARACTERISTICS								
Reverse Recovery Time	t _{RR}			30		ns		
Reverse Recovery Charge	Q _{RR}			244		nC		
Reverse Recovery Energy	E _{REC}	1		11		μJ		
Peak Reverse Recovery Current	I _{RRM}]		16		А		
Charge Time	Та]		17		ns		
Discharge Time	Tb]		13		ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

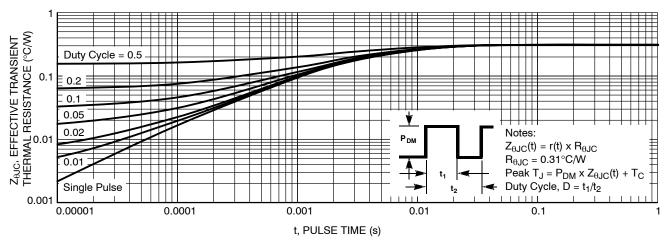


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Size	Quantity
NVH4L020N090SC1	H4L020090SC1	TO247-4L	Tube	N/A	N/A	30 Units



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

p1

Q

S

6.60

5.97

5.97

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20 5.20

18.62

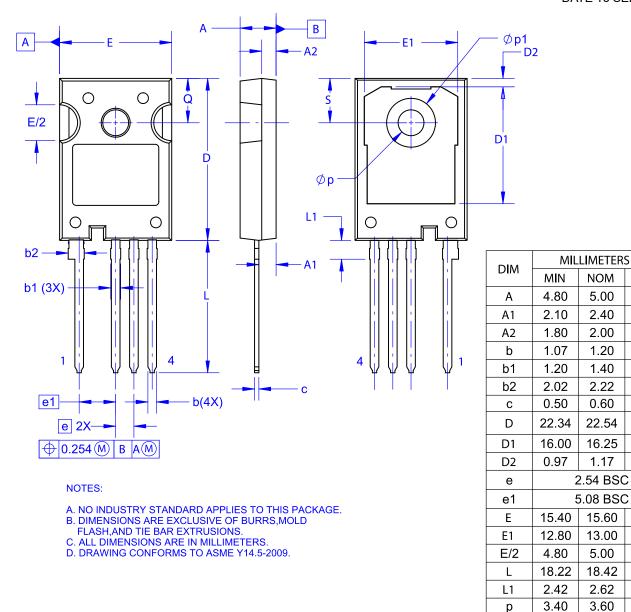
2.82

3.80

7.00

6.37

6.37



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